TPS22959 in Parallel for 30A
TPS22966 in Parallel for 10A
Assembly Note ZZ2
These assemblies are ESD sensitive, ESD precautions shall be observed.

Assembly Note ZZ3
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note ZZ4
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

PCB Number: TIDA-00513
PCB Rev: A

Texas Instruments

SH-JP21
SH-JP22
SH-JP31
SH-JP32

CO!PCB
COFID1 COFID2 COFID3

COH9 COH10 COH11 COH12

COSH0JP21 COSH0JP22 COSH0JP31 COSH0JP32

Version control disabled
SVN Rev: TIDA-00513

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Engineer: Adam Hoover
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